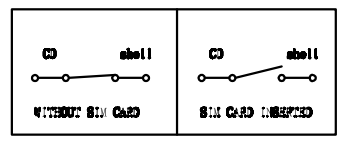


REV.	ECN.NO.	APPD.
A	/	/



\*Electrical Characteristics:  
 Contact Current Rating:0.5 Amperes.  
 Dielectric Withstanding Voltage:AC500V r.m.s.  
 Insulation Resistance:1000 MΩ Minimum.  
 Contact Resistance:100 mΩ Maximum.

\*Environmental:  
 Operating Temperature:-25°C~+90°C.

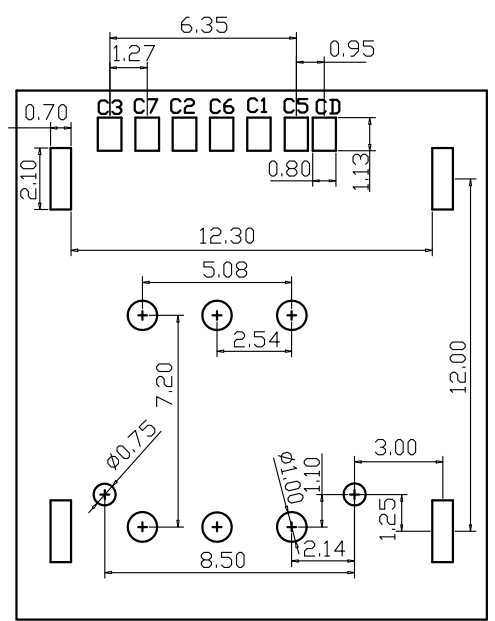
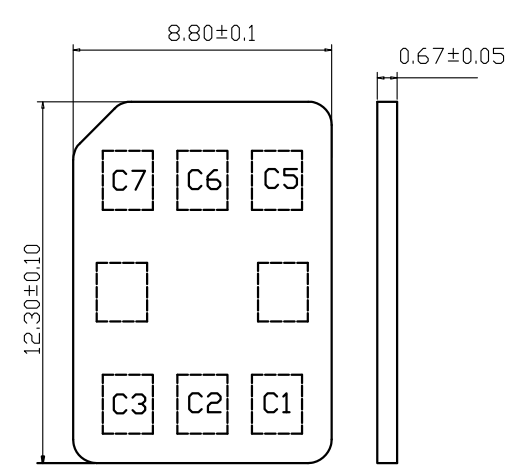
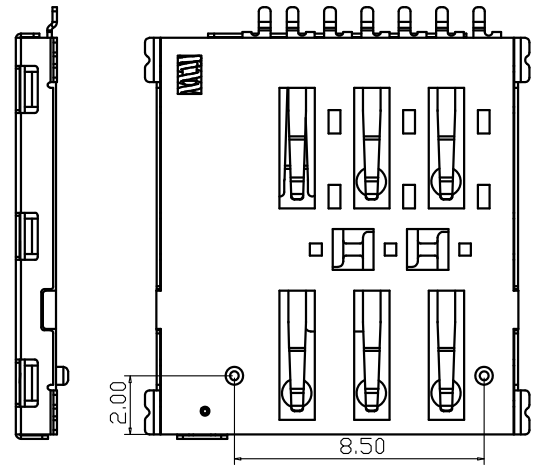
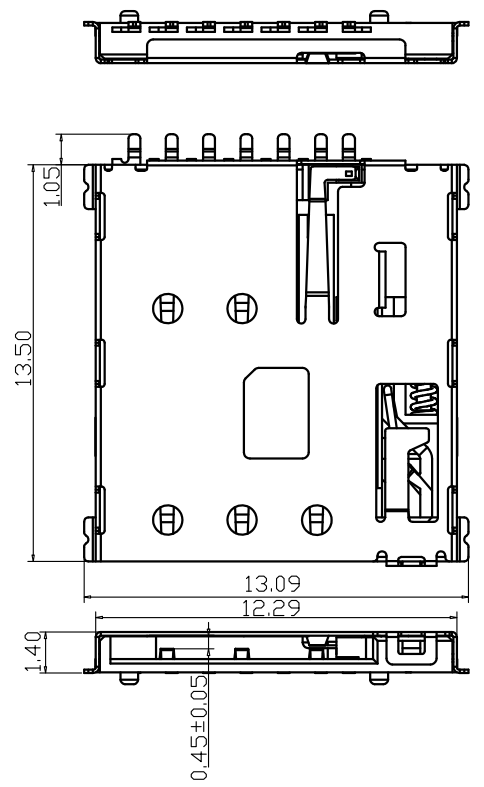
\*Environmental:  
 Mating Cycles:5000~10,000 Insertions.

\*Mechanical Characteristics:  
 Card Push Insertion/Out Force:1.4kgf. MAX  
 Contact Separation Force:0.20kgf Minimum.

\*Material:  
 Insulator:HI-Temp Plastic UL 94V-0 Rated.  
 Contact:Copper Alloy(t=0.15mm).  
 Shell:Stainless Steel(t=0.20mm).  
 Spring:SWP.

SD5211-120-G68

G:半金G/Fu 6:LCP黑色



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>FLW 深圳市华联威电子科技有限公司</b>				
.XXX ±0.10		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO.,LTD.				
.XX ±0.20		.X* ±3*				
.X ±0.30		.XX* ±2*				
APPROVED		PART NAME:	NONI SIM Modle自弹7INP卡座			
CHECKED		PART No:	SD5211-120-G68	C		
DRAWN	chenyiting	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2023. 04. 19		mm	1:1	10F1	A